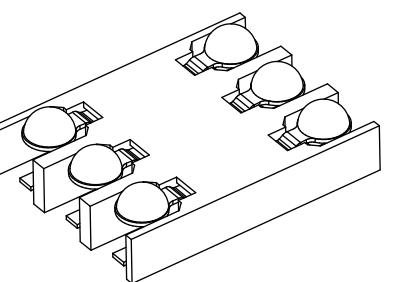
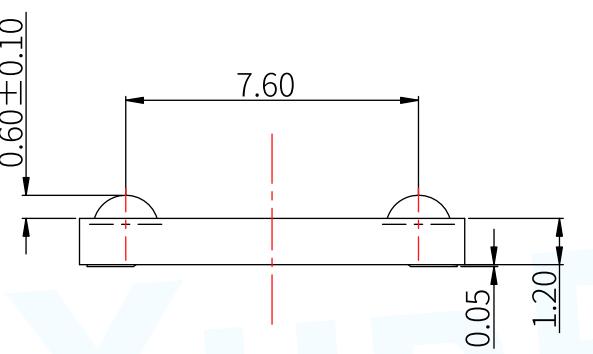
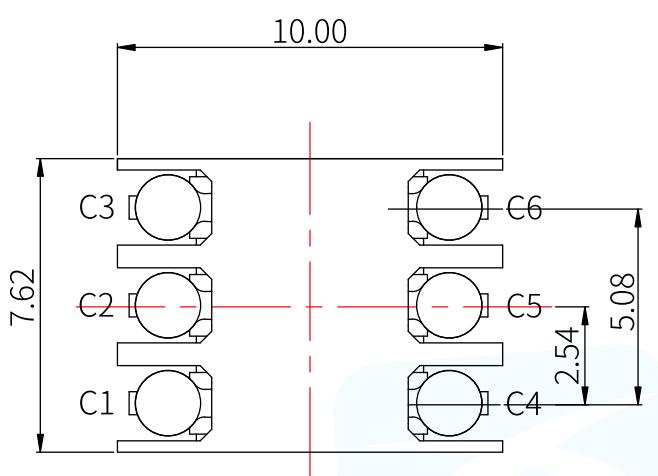
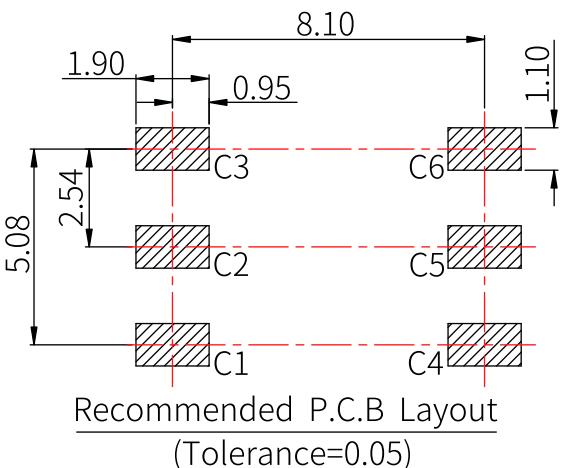


1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
ROHS Compliant											MAPX	MODIFICATION	DATE	DRAW	APPROVE



SIM CARD	
PIN#	Description
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP



NOTS:

1.Material:

Housing: HI-temp plastic UL 94V-0

Contact: Copper Alloy

2.Finish:

CONTACT: G/F" Gold plated on contact area;
G/F plated on solder tails, Base Nickel: 50u" Min

3.Part number information

MANUFACTURE DWG	 DongGuan XunPu Electronics Co,Ltd
UNLESS OTHERWISE SPECIFIED TOLERANCES	
DECIMALS: X:±0.50 .X:±3°	TITLE: 1.2H SIM CARD
.X:±0.30 .XX:±2°	PAR: SIM-101-ARP6H12
.XX:±0.20	DWN: KING 2016.07.08
	CHKD
	APVD
	SCALE 1:1 UNIT: mm
	CUSTOMER COPY SIZE:A4 SHEET:1F1 REV:A